# LOW NOISE ZENER DIODE



## 1N4626D2A / 1N4626D2B

- $V_7 = 5.6V$
- ±5% Tolerance
- Low Leakage
- Low Current
- Low Noise
- Hermetic Ceramic Surface Mount Package Designed as a Drop In Replacement for "D-5A" / "B-MELF" Package
- Space Level and High-Reliability Screening Options Available



## ABSOLUTE MAXIMUM RATINGS (T<sub>A</sub> = 25°C unless otherwise stated)

PT (1)	Total Power Dissipation at TA = 55°C	400mW
	Derate above 55°C	33mW/°C
I <sub>ZM</sub> (1)	Zener Current	65mA
IZSM	Zener Surge Current	700mA
TJ	Junction Temperature Range	-65 to +175°C
$T_{STG}$	Storage Temperature Range	-65 to +175°C
T <sub>SP</sub>	Maximum Soldering Pad Temperature for 20s	260°C

## **ELECTRICAL CHARACTERISTICS** (T<sub>A</sub> = 25°C, unless otherwise stated)

Symbols	Parameters	Test Conditions		Min	Тур	Max	Units
VZ	Zener Voltage	I <sub>ZT</sub> = 250μA		5.32	5.6	5.88	V
VF	Forward Voltage	I <sub>F</sub> = 200mA				1.1	V
Z <sub>ZT</sub>	Maximum Zener Impedance	I <sub>ZT</sub> = 250μA				1400	Ω
IR	Reverse Current	V <sub>R</sub> = 4V				5	A
		$T_A = 150$	O°C			10	μΑ
ND	Noise Density	I <sub>ZT</sub> = 250μA				4	μV/ <del>√Hz</del>
$\alpha V_Z$	Temperature Coefficient of Zener Voltage <sup>†</sup>	$I_{ZT} = 250\mu A$ $T_1 = 25^{\circ}C T_2 = 125^{\circ}C$		-0.02		+0.04	%/°C

#### **THERMAL PROPERTIES**

Symbols	Parameters	Max.	Units
R <sub>0</sub> JSP(IN)	Thermal Resistance, Junction To Solder Pads. T <sub>SP</sub> = 25°C	100	°C/W
R <sub>θ</sub> JA(PCB)	Thermal Resistance, Junction To Ambient (1)	300	°C/W

#### Notes

(1) PCB = FR4 - 0.0625 Inch (1.59mm), 1 Layer, 1.0-Oz Cu, 0.006 Inch² (1.55mm x 2.67mm²) Pad Size, horizontal, in still air.

‡ Recommended solder pad layout dimensions for this device, as detailed within this datasheet for the D-5A device.

Semelab Limited reserves the right to change test conditions, parameter limits and package dimensions without notice. Information furnished by Semelab is believed to be both accurate and reliable at the time of going to press. However Semelab assumes no responsibility for any errors or omissions discovered in its use. Semelab encourages customers to verify that datasheets are current before placing orders.



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Inches 0.197 ±0.004

 $0.103 \pm 0.004$ 

0.043 ±0.004

 $0.069 \pm 0.004$ 

**DLCC2 Variant A (D2A)** 

5.00 ±0.10

 $2.61 \pm 0.10$ 

1.08 ±0.10

 $1.76 \pm 0.10$ 

ANODE CATHODE

PAD 2

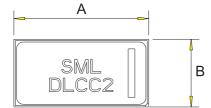
DIMENSION

В

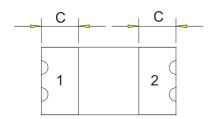
C

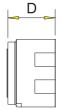
D

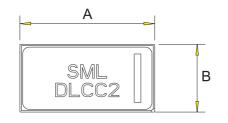
#### **MECHANICAL DATA**



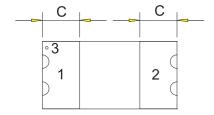








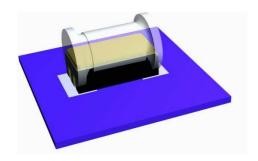




### **DLCC2 Variant B (D2B)**

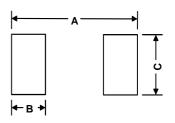
PAD 1	ANODE			
PAD 2	CATHODE			
PAD 3	LID CONTACT TO ANODE*			
DIMENSION	mm	Inches		
А	5.00 ±0.10	0.197 ±0.004		
В	2.61 ±0.10	0.103 ±0.004		
C	1.08 ±0.10	0.043 ±0.004		
D	1.76 ±0.10	0.069 ±0.004		

#### DLCC2/ D-5A MELF OVERLAY



#### **SOLDER PAD LAYOUT D-5A**

DIMENSION	mm	Inches
А	6.25	0.246
В	1.70	0.067
С	2.67	0.105



<sup>\*</sup> The additional contact provides a connection to the lid in the application. Connecting the metal lid to a known electrical potential stops deep dielectric discharge in space applications; see the Space Weather link <a href="https://www.semelab.co.uk/dlcc2.html">www.semelab.co.uk/dlcc2.html</a> on the Semelab web site. Package variant to be specified at order.

Other Package Outlines may be available - Contact Semelab Sales to Enquire

# LOW NOISE ZENER DIODE 1N4626D2A / 1N4626D2B



#### **SCREENING OPTIONS**

Space Level (JQRS/ESA) and High Reliability options are available in accordance with the <u>High Reliability and Screening Options Handbook</u> available for download from the from the TT electronics Semelab web site.

ESA Quality Level Products are based on the testing procedures specified in the generic ESCC 5000 and in the corresponding part detail specifications.

Semelabs QR216 and QR217 processing specifications (JQRS), in conjunction with the companies ISO 9001:2000 approval present a viable alternative to the American MIL-PRF-19500 space level processing.

QR217 (Space Level Quality Conformance) is based on the quality conformance inspection requirements of MIL-PRF-19500 groups A (table V), B (table VIa), C (table VII) and also ESA / ESCC 5000 (chart F4) lot validation tests.

QR216 (Space Level Screening) is based on the screening requirements of MIL-PRF-19500 (table IV) and also ESA /ESCC 5000 (chart F3).

JQRS parts are processed to the device data sheet and screened to QR216 with conformance testing to Q217 groups A and B in accordance with MIL-STD-750 methods and procedures.

Additional conformance options are available, for example Pre-Cap Visual Inspection, Buy-Off Visit or Data Packs. These are chargeable and must be specified at the order stage (See Ordering Information). Minimum order quantities may apply.

Alternative or additional customer specific conformance or screening requirements would be considered. Contact Semelab sales with enquires.

#### **MARKING DETAILS**

Parts can be laser marked with approximately 7 characters on two lines and always includes cathode identification. Typical marking would include part or specification number, week of seal or serial number subject to available space and legibility.

Customer specific marking requirements can be arranged at the time of order.

Example Marking:



#### **ORDERING INFORMATION**

Part numbers are built up from Type, Package Variant, and screening level. The part numbers are extended to include the additional options as shown below.

Type – See Main Part Number Package Variant – See Mechanical Data Screening Level – See Screening Options (ESA / JQRS)

#### Additional Options:

Customer Pre-Cap Visual Inspection	.CVP
Customer Buy-Off visit	.CVB
Data Pack	.DA
Solderability Samples	.SS
Scanning Electron Microscopy	.SEM
Radiography (X-ray)	.XRAY
Total Dose Radiation Test	.RAD
MIL-PRF-19500 (QR217)	
Group B charge	.GRPB
Group B destructive mechanical samples	.GBDM (12 pieces)
Group C charge	.GRPC
Group C destructive electrical samples	.GCDE (12 pieces)
Group C destructive mechanical samples	.GCDM (6 pieces)
ESA/ESCC	
Lot Validation Testing (subgroup 1) charge	.LVT1
LVT1 destructive samples (environmental)	.L1DE (15 pieces)
LVT1 destructive samples (mechanical)	.L1DM (15 pieces)
Lot Validation Testing (subgroup 2) charge	.LVT2
LVT2 endurance samples (electrical)	.L2D (15 pieces)
Lot Validation Testing (subgroup 3) charge	.LVT3
LVT3 destructive samples (mechanical)	.L3D (5 pieces)
A 1177 1 1 0 17 11 1	

Additional Option Notes:

- All 'Additional Options' are chargeable and must be specified at order stage.
- When Group B,C or LVT is required, additional electrical and mechanical destructive samples must be ordered
- 3) All destructive samples are marked the same as other production parts unless otherwise requested.

#### Example ordering information:

The following example is for the 1N4626 part with package variant A, JQRS screening, additional Group C conformance testing and a Data pack.

#### Part Numbers:

1N4626D2A-JQRS (Include quantity for flight parts)
1N4626D2A-JQRS.GRPC (chargeable conformance option)
1N4626D2A-JQRS.GCDE (charge for destructive parts)
1N4626D2A-JQRS.GCDM (charge for destructive parts)
1N4626D2A-JQRS.DA (charge for Data pack)

Customers with any specific requirements (e.g. marking or screening) may be supplied with a similar alternative part number (there is maximum 20 character limit to part numbers). Contact Semelab sales with enquiries

High Reliability and Screening Options Handbook link: http://www.semelab.co.uk/pdf/misc/documents/hirel\_and\_screening\_options.pdf